

MOS FIELD EFFECT TRANSISTOR μ PA1725

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

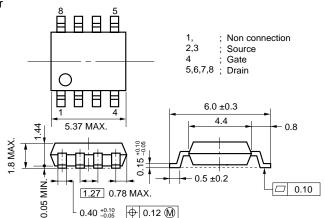
DESCRIPTION

This μ PA1725 is N-Channel MOS Field Effect Transistor designed for power management applications of notebook computers and so on.

FEATURES

- 2.5-V gate drive and low on-resistance
 - $R_{DS(on)1} = 21.0 \text{ m}\Omega \text{ MAX.} \text{ (Vgs} = 4.5 \text{ V, ID} = 3.5 \text{ A)}$
 - $R_{DS(on)2} = 22.0 \text{ m}\Omega$ MAX. (Vgs = 4.0 V, ID = 3.5 A)
 - RDS(on)3 = 30.0 m Ω MAX. (Vgs = 2.5 V, ID = 3.5 A)
- Low Ciss: Ciss = 950 pF TYP.
- · Built-in G-S protection diode
- Small and surface mount package (Power SOP8)

PACKAGE DRAWING (Unit: mm)



ORDERING INFORMATION

PART NUMBER	PACKAGE
μPA1725G	Power SOP8

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, All terminals are connected.)

Drain to Source Voltage (Vgs = 0 V)	Voss	20	V	EQUIVALENT OFFICE
Gate to Source Voltage (Vps = 0 V)	Vgss	±12	V	EQUIVALENT CIRCUIT
Drain Current (DC)	ID(DC)	±7	Α	Drain
Drain Current (pulse) Note1	ID(pulse)	±28	Α	P
Total Power Dissipation (T _A = 25°C) Note2	Рт	2.0	W	Gate Body
Channel Temperature	Tch	150	°C	¥-
Storage Temperature	T_{stg}	-55 to + 150	°C	Gate
Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1 %				Protection Source Diode

2. Mounted on ceramic substrate of 1200 mm² x 2.2mm

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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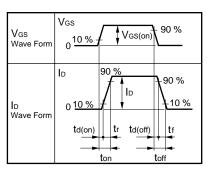


ELECTRICAL CHARACTERISTICS (T_A = 25 °C, All terminals are connected.)

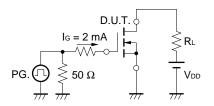
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	Vgs = 4.5 V, ID = 3.5 A		16.5	21.0	mΩ
	RDS(on)2	Vgs = 4.0 V, ID = 3.5 A		17.0	22.0	mΩ
	RDS(on)3	Vgs = 2.5 V, ID = 3.5 A		22.0	30.0	mΩ
Gate to Source Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	0.5	1.0	1.5	V
Forward Transfer Admittance	yfs	V _{DS} = 10 V, I _D = 3.5 A	5.0	11.0		S
Drain Leakage Current	IDSS	Vps = 20 V, Vgs = 0 V			10	μΑ
Gate to Source Leakage Current	lgss	Vgs = ±12 V, Vps = 0 V			±10	μΑ
Input Capacitance	Ciss	Vps = 10 V		950		pF
Output Capacitance	Coss	Vgs = 0 V		310		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		160		pF
Turn-on Delay Time	td(on)	ID = 3.5 A		30		ns
Rise Time	tr	V _{GS(on)} = 4.5 V		120		ns
Turn-off Delay Time	td(off)	V _{DD} = 10 V		70		ns
Fall Time	t _f	$R_G = 10 \Omega$		70		ns
Total Gate Charge	QG	ID = 7 A		9.6		nC
Gate to Source Charge	Qgs	VDD = 16 V		1.7		nC
Gate to Drain Charge	Q _{GD}	Vgs = 4.5 V		4.1		nC
Body Diode Forward Voltage	VF(S-D)	IF = 7 A, VGS = 0 V		0.8		V
Reverse Recovery Time	trr	IF = 7 A, VGS = 0 V		40		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ μs		27		nC

TEST CIRCUIT 2 SWITCHING TIME

PG. \bigcap R_G ∇_{GS} ∇_{GS

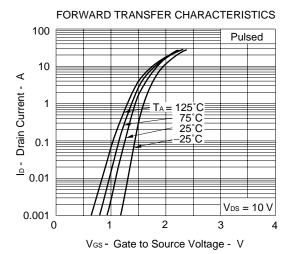


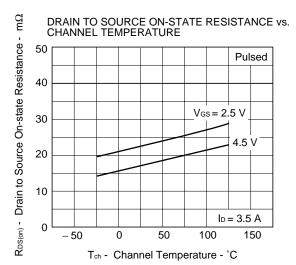
TEST CIRCUIT 3 GATE CHARGE

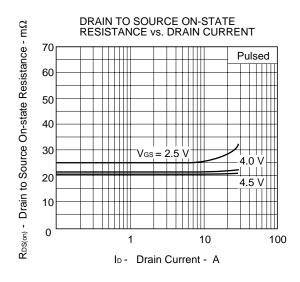


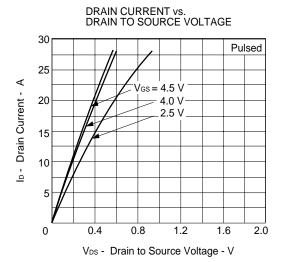


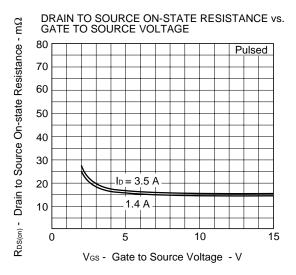
TYPICAL CHARACTERISTICS (TA = 25 °C, All terminals are connected.)

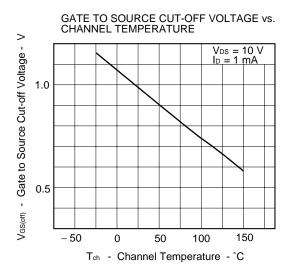




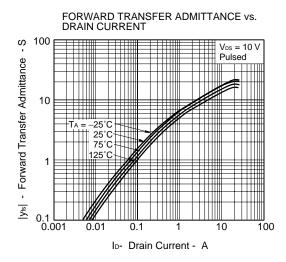


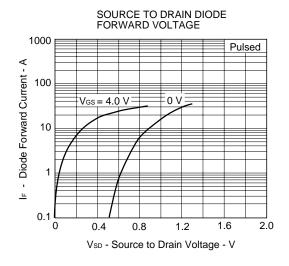


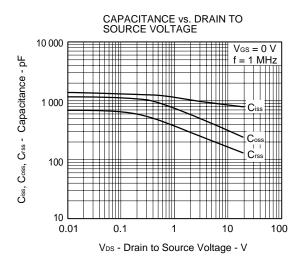


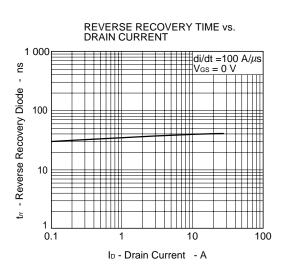


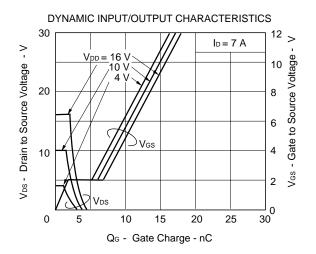
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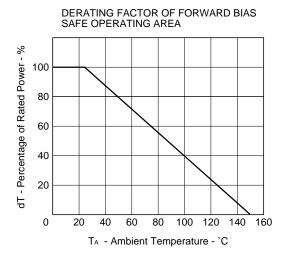


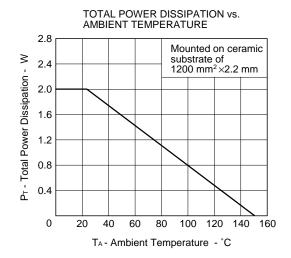


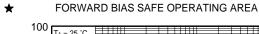


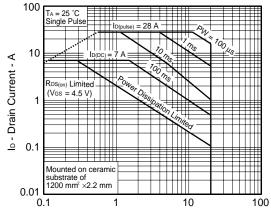






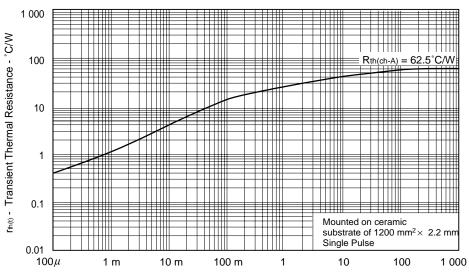






V_{DS} - Drain to Source Voltage - V

TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



PW - Pulse Width - s

Data Sheet G14049EJ2V0DS

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[MEMO]

[MEMO]

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